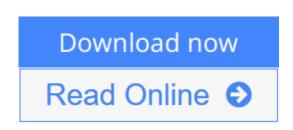


Chip On Board: Technology for Multichip Modules (E; Ectrical Engineering)

By John H. Lau



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This book is a one-stop guide to the state of the art of COB technology. For professionals active in COB and MCM research and development, those who wish to master COB and MCM problem-solving methods, and those who must choose a cost-effective design and high-yield manufacturing process for their interconnect systems, here is a timely summary of progress in al aspects of this fascinating field.

It meets the reference needs of design, material, process, equipment, manufacturing, quality, reliability, packaging, and system engineers, and technical managers working in electronic packaging and interconnection.

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Chip On Board: Technology for Multichip Modules (E; Ectrical Engineering) By John H. Lau Bibliography

- Sales Rank: #3412345 in Books
- Published on: 1994-01-15
- Original language: English
- Number of items: 1
- Dimensions: 9.21" h x 1.25" w x 6.14" l, 2.04 pounds
- Binding: Hardcover
- 556 pages

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